

# The Dual-mode Bluetooth® Module You've Been Waiting for Is Here



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It's here! Our new dual-mode *Bluetooth*® CC2564 module ([CC2564MODA](#)) enables developers to get their simple, low-power connectivity solutions to market quickly and easily. Featuring an integrated antenna and the flexibility to support multiple microcontrollers (MCUs) and microprocessors (MPUs), the module delivers best-in-class range and performance for a variety of audio, wearable, industrial, medical and Internet of Things (IoT) applications.

## Why Is This Exciting?



*Dual-mode Bluetooth CC2564 module with integrated antenna evaluation board (front)*

It's easy to use – Having a module with an integrated antenna is a simple way for anyone to add Bluetooth to their system. Our new module allows for development with no prior RF expertise necessary.

It's a robust solution – The new CC2564 module speeds up time to market because of its certified RF design. The modules are Bluetooth 4.1 compliant and FCC/IC/CE certified, ensuring interoperability and providing a significant cost savings when transferred to end products.

It provides design flexibility – TI makes it easy to develop Bluetooth applications for multiple MCU/MPUs with the flexibility of multiple devices and tools, software and support. The new CC2564 module was designed to work with a wide variety of MCU/MPUs including TI's [MSP430™ MCUs](#), [TM4C MCUs](#) and [Sitara™ AM335x processors](#) as well as options outside of our portfolio. TI also offers flexible software options for the module including a royalty-free TI-supported stack, with multiple profiles and sample applications for Bluetooth and Bluetooth low energy.

## Where Do I Start?

The new dual-mode Bluetooth CC2564 modules are available now through the TI Store and through TI authorized distributors. Start the design process now by doing one of the following:

1. [Order the modules](#) through TI.com or an authorized distributor
  - a. The modules (CC2564MODA) are available for \$8.70 in 1,000 unit volumes
2. [Order an evaluation board](#) (CC2564MODAEM) for \$19.99
3. [Request a sample](#)

## Want Even More Good News?

A [BoosterPack™ plug-in module](#) for this solution is now available to help kick-start your design along with [software stack](#) support on the [MSP432™ MCU platform](#). For more information, documentation and more on the dual-mode Bluetooth CC2564 module with integrated antenna, click the button below.

**Click here to learn more about the dual-mode  
Bluetooth CC2564 module with integrated antenna**

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